

## DIGITAL TV TUNER IC

### FEATURES

- Integrated Mixer/Oscillator/PLL and IF GCA
- VHF-L, VHF-H, UHF 3-Band Local Oscillator
- RF AGC Detector Circuit
- External 4-Pin IF Filter Between Mixer Output and IF Amplifier Input
- I<sup>2</sup>C Bus Protocol Bidirectional Data Transmission
- High-Voltage Tuning Voltage Output
- Four NPN-Type Band-Switch Drivers
- One Auxiliary Port/5-Level ADC
- Crystal Oscillator Output
- Programmable Reference Divider Ratio (24/28/50/64/80/128)
- Low Distortion IF Gain Controlled Amplifier
- Standby Mode
- 5-V Power Supply
- 44-Pin Thin Shrink Small-Outline Package (TSSOP)

### APPLICATIONS

- Digital TVs
- Digital CATVs
- Set-Top Boxes

### DESCRIPTION

The SN761668 is a low-phase-noise synthesized tuner IC designed for digital TV tuning systems. The circuit consists of a PLL synthesizer, three-band local oscillator and mixer, RF AGC detector circuit, and IF gain-controlled amplifier. The SN761668 is available in a small-outline package.

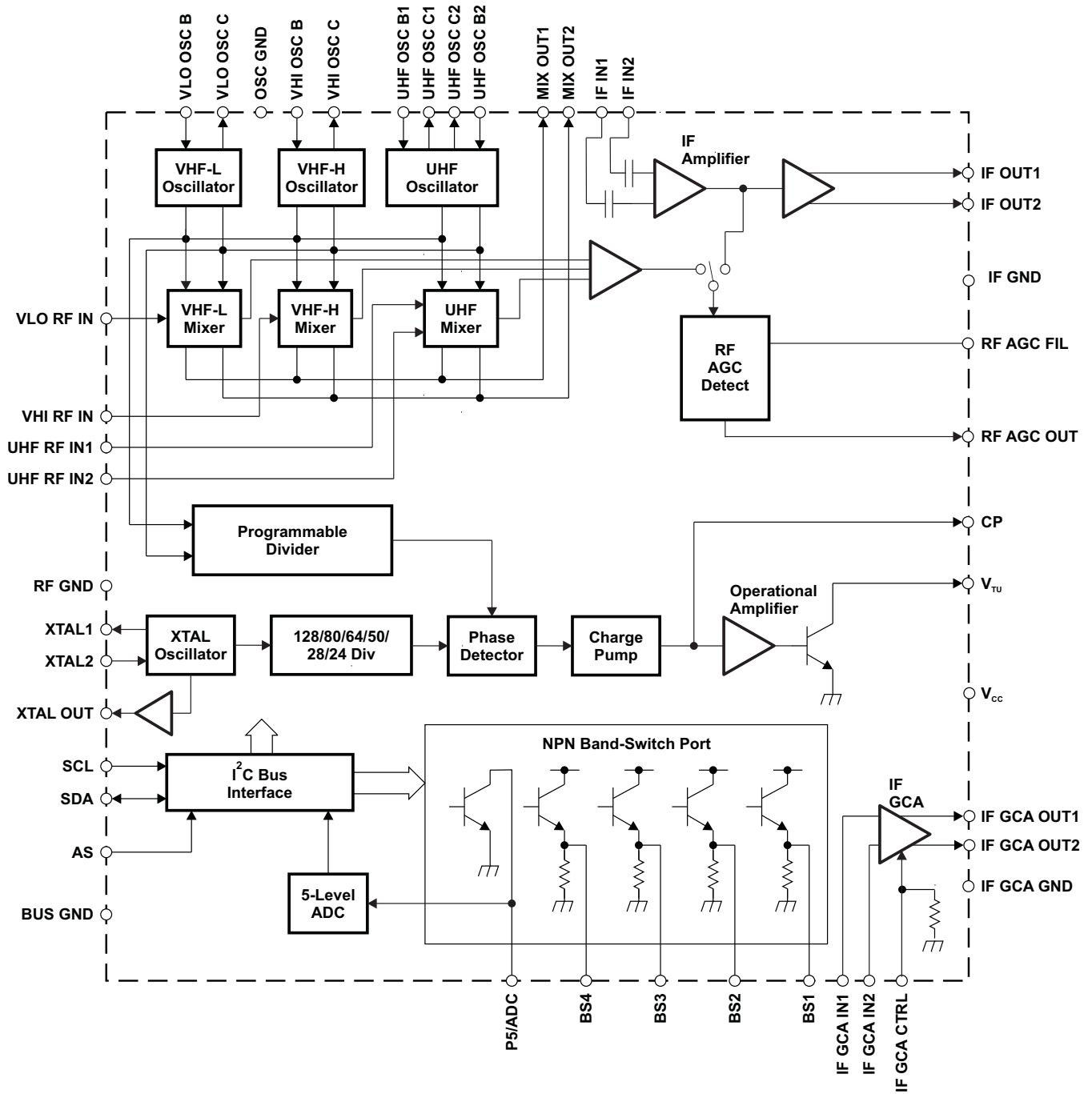
**DBT PACKAGE  
(TOP VIEW)**

|                 |    |   |    |            |
|-----------------|----|---|----|------------|
| VLO OSC B       | 1  | ○ | 44 | BS4        |
| VLO OSC C       | 2  |   | 43 | UHF RF IN1 |
| VHI OSC B       | 3  |   | 42 | UHF RF IN2 |
| VHI OSC C       | 4  |   | 41 | VHI RF IN  |
| OSC GND         | 5  |   | 40 | VLO RF IN  |
| UHF OSC B1      | 6  |   | 39 | RF GND     |
| UHF OSC C1      | 7  |   | 38 | MIXOUT2    |
| UHF OSC C2      | 8  |   | 37 | MIXOUT1    |
| UHF OSC B2      | 9  |   | 36 | IF IN2     |
| IF GND          | 10 |   | 35 | IF IN1     |
| IF OUT1         | 11 |   | 34 | RF AGC OUT |
| IF OUT2         | 12 |   | 33 | RF AGC FIL |
| CP              | 13 |   | 32 | BS3        |
| VTU             | 14 |   | 31 | BS2        |
| V <sub>cc</sub> | 15 |   | 30 | BS1        |
| IF GCA IN1      | 16 |   | 29 | SDA        |
| IF GCA IN2      | 17 |   | 28 | SCL        |
| IF GCA CTRL     | 18 |   | 27 | AS         |
| IF GCA GND      | 19 |   | 26 | BUS GND    |
| IF GCA OUT2     | 20 |   | 25 | XTAL OUT   |
| IF GCA OUT1     | 21 |   | 24 | XTAL2      |
| P5/ADC          | 22 |   | 23 | XTAL1      |



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

FUNCTIONAL BLOCK DIAGRAM



## TERMINAL FUNCTIONS

| TERMINAL<br>NAME | NO. | DESCRIPTION                                  | SCHEMATIC                 |
|------------------|-----|--|---------------------------|
| AS               | 27  | Address selection input                      | <a href="#">Figure 1</a>  |
| BS1              | 30  | Band-switch 1 output                         | <a href="#">Figure 2</a>  |
| BS2              | 31  | Band-switch 2 output                         | <a href="#">Figure 2</a>  |
| BS3              | 32  | Band-switch 3 output                         | <a href="#">Figure 2</a>  |
| BS4              | 44  | Band-switch 4 output                         | <a href="#">Figure 2</a>  |
| BUS GND          | 26  | BUS ground                                   |                           |
| CP               | 13  | Charge-pump output                           | <a href="#">Figure 3</a>  |
| IF GCA CTRL      | 18  | IF GCA CTRL voltage inout                    | <a href="#">Figure 4</a>  |
| IF GCA GND       | 19  | IF GCA ground                                |                           |
| IF GCA IN1       | 16  | IF GCA input 1                               | <a href="#">Figure 5</a>  |
| IF GCA IN2       | 17  | IF GCA input 2                               | <a href="#">Figure 5</a>  |
| IF GCA OUT1      | 21  | IF GCA output 1                              | <a href="#">Figure 6</a>  |
| IF GCA OUT2      | 20  | IF GCA output 2                              | <a href="#">Figure 6</a>  |
| IF GND           | 10  | IF ground                                    |                           |
| IF IN1           | 35  | IF amplifier input 1                         | <a href="#">Figure 7</a>  |
| IF IN2           | 36  | IF amplifier input 2                         | <a href="#">Figure 7</a>  |
| IF OUT1          | 11  | IF amplifier output 1                        | <a href="#">Figure 8</a>  |
| IF OUT2          | 12  | IF amplifier output 2                        | <a href="#">Figure 8</a>  |
| MIXOUT1          | 37  | Mixer output 1                               | <a href="#">Figure 9</a>  |
| MIXOUT2          | 38  | Mixer output 2                               | <a href="#">Figure 9</a>  |
| OSC GND          | 5   | Oscillator ground                            |                           |
| P5/ADC           | 22  | Port-5 output/ADC input                      | <a href="#">Figure 10</a> |
| RF AGC FIL       | 33  | RF AGC additional capacitor pin              | <a href="#">Figure 11</a> |
| RF AGC OUT       | 34  | RF AGC output                                | <a href="#">Figure 12</a> |
| RF GND           | 39  | RF ground                                    |                           |
| SCL              | 28  | Serial clock input                           | <a href="#">Figure 13</a> |
| SDA              | 29  | Serial data input/output                     | <a href="#">Figure 14</a> |
| UHF OSC B1       | 6   | UHF oscillator base 1                        | <a href="#">Figure 15</a> |
| UHF OSC B2       | 9   | UHF oscillator base 2                        | <a href="#">Figure 15</a> |
| UHF OSC C1       | 7   | UHF oscillator collector 1                   | <a href="#">Figure 15</a> |
| UHF OSC C2       | 8   | UHF oscillator collector 2                   | <a href="#">Figure 15</a> |
| UHF RF IN1       | 43  | UHF RF input 1                               | <a href="#">Figure 16</a> |
| UHF RF IN2       | 42  | UHF RF input 2                               | <a href="#">Figure 16</a> |
| V <sub>CC</sub>  | 15  | Supply voltage for mixer/oscillator/PLL: 5 V |                           |
| VHI OSC B        | 3   | VHF-H oscillator base                        | <a href="#">Figure 17</a> |
| VHI OSC C        | 4   | VHF-H oscillator collector                   | <a href="#">Figure 17</a> |
| VHI RF IN        | 41  | VHF-H RF input                               | <a href="#">Figure 18</a> |
| VLO OSC B        | 1   | VHF-L oscillator base                        | <a href="#">Figure 19</a> |
| VLO OSC C        | 2   | VHF-L oscillator collector                   | <a href="#">Figure 19</a> |
| VLO RF IN        | 40  | VHF-L RF input                               | <a href="#">Figure 20</a> |
| VTU              | 14  | Tuning voltage amplifier output              | <a href="#">Figure 3</a>  |
| XTAL1            | 23  | 4-MHz crystal oscillator output              | <a href="#">Figure 21</a> |
| XTAL2            | 24  | 4-MHz crystal oscillator input               | <a href="#">Figure 21</a> |
| XTALOUT          | 25  | 4-MHz crystal oscillator output              | <a href="#">Figure 22</a> |

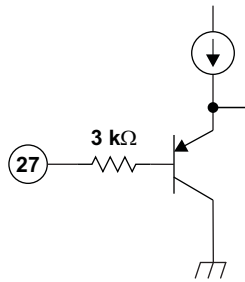


Figure 1. AS

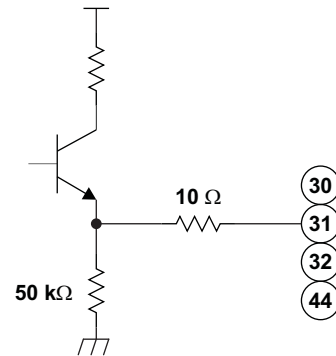


Figure 2. BS1, BS2, BS3, and BS4

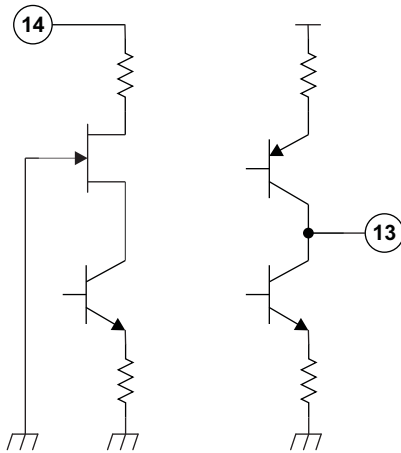


Figure 3. CP and VTU

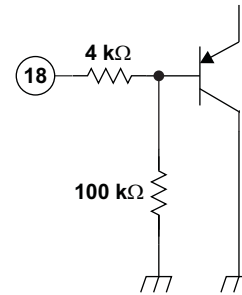


Figure 4. IF GCA CTRL

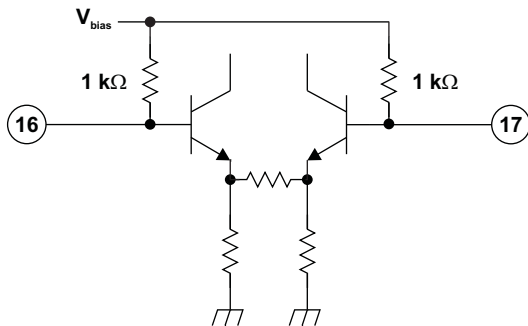


Figure 5. IF GCA IN1 and IF GCA IN2

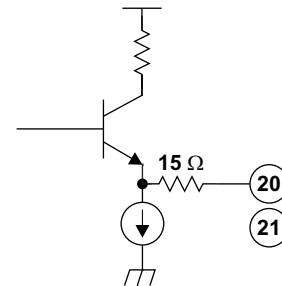


Figure 6. IF GCA OUT1 and IF GCA OUT2

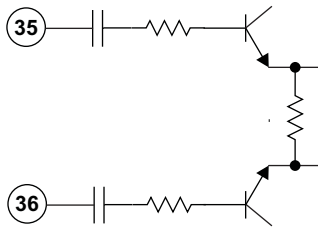


Figure 7. IF IN1 and IF IN2

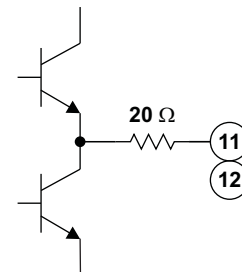


Figure 8. IF OUT1 and IF OUT2

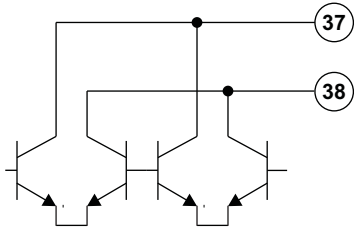


Figure 9. MIXOUT1 and MIXOUT2

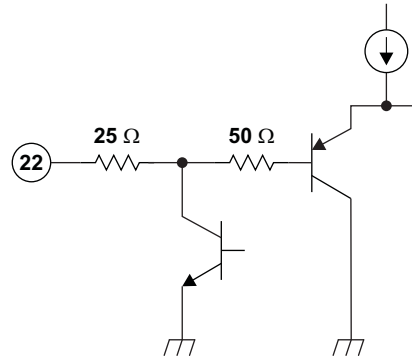


Figure 10. P5/ADC

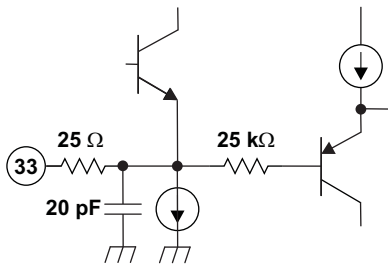


Figure 11. RF AGC FIL

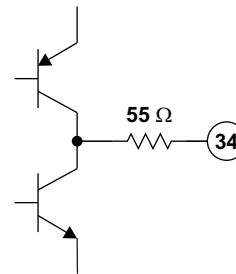


Figure 12. RF AGC OUT

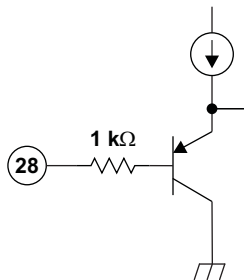


Figure 13. SCL

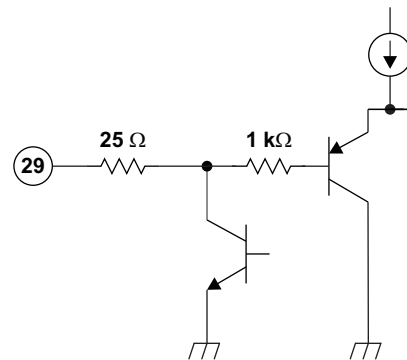


Figure 14. SDA

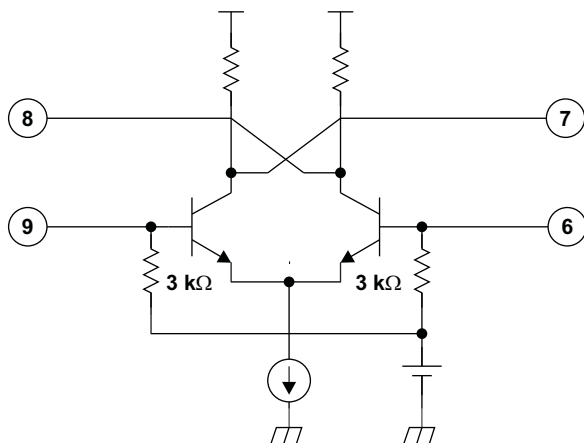


Figure 15. UHF OSC B1, UHF OSC B2, UHF OSC C1, and UHF OSC C2

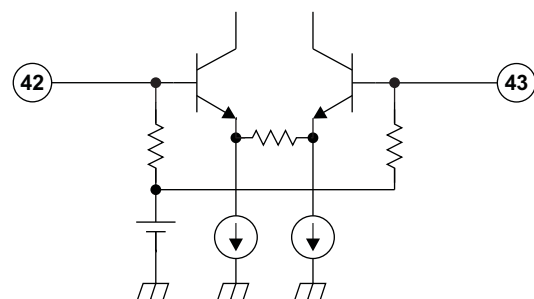


Figure 16. UHF RF IN1 and UHF RF IN2

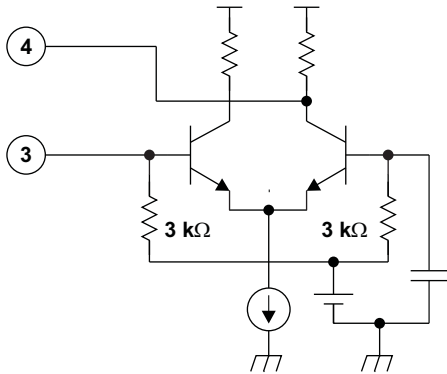


Figure 17. VHI OSC B and VHI OSC C

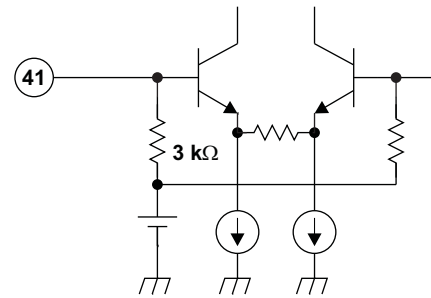


Figure 18. VHI RF IN

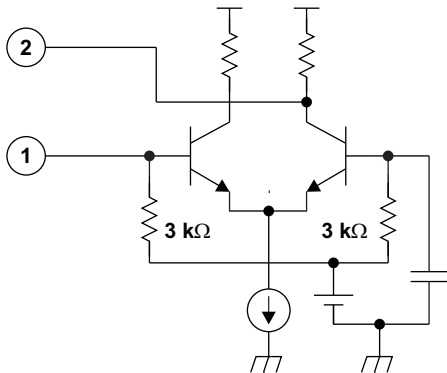


Figure 19. VLO OSC B and VLO OSC C

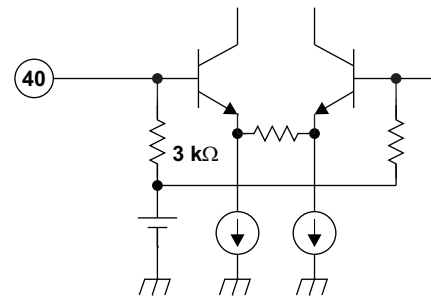


Figure 20. VLO RF IN

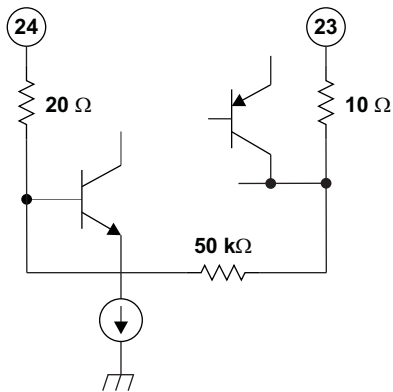


Figure 21. XTAL1 and XTAL2

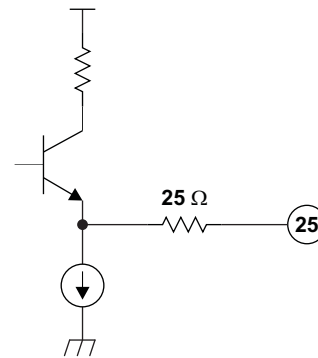


Figure 22. XTALOUT

## ABSOLUTE MAXIMUM RATINGS<sup>(1)</sup>

over recommended operating free-air temperature range (unless otherwise noted)

|                      |   |                                       | MIN  | MAX  | UNIT |
|----------------------|---|---------------------------------------|------|------|------|
| V <sub>CC</sub>      | Supply voltage range <sup>(2)</sup>         | V <sub>CC</sub>                       | –0.4 | 6.5  | V    |
| V <sub>GND</sub>     | Input voltage range 1 <sup>(2)</sup>        | RF GND, OSC GND                       | –0.4 | 0.4  | V    |
| VTU                  | Input voltage range 2 <sup>(2)</sup>        | VTU                                   | –0.4 | 35   | V    |
| V <sub>IN</sub>      | Input voltage range 3 <sup>(2)</sup>        | Other pins                            | –0.4 | 6.5  | V    |
| P <sub>D</sub>       | Continuous total dissipation <sup>(3)</sup> | T <sub>A</sub> ≤ 25°C                 |      | 1438 | mW   |
| T <sub>A</sub>       | Operating free-air temperature range        |                                       | –20  | 85   | °C   |
| T <sub>stg</sub>     | Storage temperature range                   |                                       | –65  | 150  | °C   |
| T <sub>J</sub>       | Maximum junction temperature                |                                       |      | 150  | °C   |
| t <sub>SC(max)</sub> | Maximum short-circuit time                  | Each pin to V <sub>CC</sub> or to GND |      | 10   | s    |

- (1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) Voltage values are with respect to the IF GND of the circuit.
- (3) Derating factor is 11.5 mW/°C for T<sub>A</sub> ≥ 25°C.

## RECOMMENDED OPERATING CONDITIONS

|                 |                                |                               | MIN | NOM | MAX | UNIT |
|-----------------|--------------------------------|-------------------------------|-----|-----|-----|------|
| V <sub>CC</sub> | Supply voltage                 |                               | 4.5 | 5   | 5.5 | V    |
| VTU             | Tuning supply voltage          |                               |     | 30  | 33  | V    |
| I <sub>BS</sub> | Output current of band switch  | BS1 – BS4, one band switch on |     |     | 10  | mA   |
| I <sub>P5</sub> | Output current of port 5       | P5/ADC                        |     |     | –5  | mA   |
| T <sub>A</sub>  | Operating free-air temperature |                               | –20 |     | 85  | °C   |



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

IF IN1, IF IN2, MIXOUT1, and MIXOUT2 (pins 35–38) withstand 1.5 kV, and all other pins withstand 2 kV, according to the Human-Body Model (1.5 kΩ, 100 pF).

## ELECTRICAL CHARACTERISTICS

### Total Device and Serial Interface

$V_{CC} = 4.5\text{ V to }5.5\text{ V}$ ,  $T_A = -20^\circ\text{C to }85^\circ\text{C}$  (unless otherwise noted)

| PARAMETER                       |  | TEST CONDITIONS                                | MIN | TYP | MAX      | UNIT          |
|---------------------------------|--|--|-----|-----|----------|---------------|
| $I_{CC1}$                       | Supply current 1   |  |     | 115 | 140      | mA            |
| $I_{CC2}$                       | Supply current 2   | One band switch on ( $I_{BS} = 10\text{ mA}$ ) |     | 125 | 150      | mA            |
| $I_{CC-STBY}$                   | Standby supply current   | STBY = 1                                       |     | 9   |          | mA            |
| $V_{IH}$                        | High-level input voltage (SCL, SDA)  |  | 2.5 |     |          | V             |
| $V_{IL}$                        | Low-level input voltage (SCL, SDA)   |  |     |     | 1.35     | V             |
| $I_{IH}$                        | High-level input current (SCL, SDA)  |  |     |     | 10       | $\mu\text{A}$ |
| $I_{IL}$                        | Low-level input current (SCL, SDA)   |  | -10 |     |          | $\mu\text{A}$ |
| $V_{POR}$                       | Power-on-reset supply voltage (threshold of supply voltage between reset and operation mode) |  | 2.1 | 2.8 | 3.5      | V             |
| <b>I<sup>2</sup>C Interface</b> |  |  |     |     |          |               |
| $V_{ASH}$                       | Address-select high-input voltage (AS)   | $V_{CC} = 5\text{ V}$                          | 4.5 |     | 5        | V             |
| $V_{ASM1}$                      | Address-select mid-input 1 voltage (AS)  | $V_{CC} = 5\text{ V}$                          | 2   |     | 3        | V             |
| $V_{ASM2}$                      | Address-select mid-input 2 voltage (AS)  | $V_{CC} = 5\text{ V}$                          | 1   |     | 1.5      | V             |
| $V_{ASL}$                       | Address-select low-input voltage (AS)  | $V_{CC} = 5\text{ V}$                          |     |     | 0.5      | V             |
| $I_{ASH}$                       | Address-select high-input current (AS)   |  |     |     | 50       | $\mu\text{A}$ |
| $I_{ASL}$                       | Address-select low-input current (AS)  |  | -10 |     |          | $\mu\text{A}$ |
| $V_{ADC}$                       | ADC input voltage  | See <a href="#">Table 10</a>                   | 0   |     | $V_{CC}$ | V             |
| $I_{ADH}$                       | ADC high-level input current   | $V_{ADC} = V_{CC}$                             |     |     | 10       | $\mu\text{A}$ |
| $I_{ADL}$                       | ADC low-level input current  | $V_{ADC} = 0\text{ V}$                         | -10 |     |          | $\mu\text{A}$ |
| $V_{OL}$                        | Low-level output voltage (SDA)   | $V_{CC} = 5\text{ V}$ , $I_{OL} = 3\text{ mA}$ |     |     | 0.4      | V             |
| $I_{SDAH}$                      | High-level output leakage current (SDA)  | $V_{SDA} = 5.5\text{ V}$                       |     |     | 10       | $\mu\text{A}$ |
| $f_{SCL}$                       | Clock frequency (SCL)  |  |     | 100 | 400      | kHz           |
| $t_{HD-DAT}$                    | Data hold time   | See <a href="#">Figure 23</a>                  | 0   |     | 0.9      | $\mu\text{s}$ |
| $t_{BUF}$                       | Bus free time  |  | 1.3 |     |          | $\mu\text{s}$ |
| $t_{HD-STA}$                    | Start hold time  |  | 0.6 |     |          | $\mu\text{s}$ |
| $t_{LOW}$                       | SCL-low hold time  |  | 1.3 |     |          | $\mu\text{s}$ |
| $t_{HIGH}$                      | SCL-high hold time   |  | 0.6 |     |          | $\mu\text{s}$ |
| $t_{SU-STA}$                    | Start setup time   |  | 0.6 |     |          | $\mu\text{s}$ |
| $t_{SU-DAT}$                    | Data setup time  |  | 0.1 |     |          | $\mu\text{s}$ |
| $t_r$                           | Rise time (SCL, SDA)   |  |     |     | 0.3      | $\mu\text{s}$ |
| $t_f$                           | Fall time (SCL, SDA)   |  |     |     | 0.3      | $\mu\text{s}$ |
| $t_{SU-STO}$                    | Stop setup time  |  | 0.6 |     |          | $\mu\text{s}$ |



## PLL and Band Switch

 $V_{CC} = 4.5\text{ V to }5.5\text{ V}$ ,  $T_A = -20^\circ\text{C to }85^\circ\text{C}$  (unless otherwise noted)

| PARAMETER    |  | TEST CONDITIONS   | MIN | TYP  | MAX   | UNIT             |
|--------------|--|---|-----|------|-------|------------------|
| N            | Divider ratio                                | 15-bit frequency word   | 512 |      | 32767 |                  |
| $f_{XTAL}$   | Crystal oscillator frequency                 | $R_{XTAL} = 25\ \Omega$ to $300\ \Omega$  |     | 4    |       | MHz              |
| $Z_{XTAL}$   | Crystal oscillator input impedance           | $V_{CC} = 5\text{ V}$ , $T_A = 25^\circ\text{C}$  | 1.6 | 2.4  |       | k $\Omega$       |
| $V_{XLO}$    | XTALOUT output voltage                       | Load = $10\text{ pF}/5.1\text{ k}\Omega$ , $V_{CC} = 5\text{ V}$ , $T_A = 25^\circ\text{C}$ |     | 0.4  |       | V <sub>p-p</sub> |
| $V_{VTUL}$   | Tuning amplifier low-level output voltage    | $R_L = 22\text{ k}\Omega$ , $VTU = 33\text{ V}$   | 0.2 | 0.3  | 0.46  | V                |
| $I_{VTUOFF}$ | Tuning amplifier leakage current             | Tuning amplifier = off, $VTU = 33\text{ V}$   |     |      | 10    | $\mu\text{A}$    |
| $I_{CP11}$   | Charge-pump current                          | CP[1:0] = 11  |     | 600  |       | $\mu\text{A}$    |
| $I_{CP10}$   |  | CP[1:0] = 10  |     | 350  |       |                  |
| $I_{CP01}$   |  | CP[1:0] = 01  |     | 140  |       |                  |
| $I_{CP00}$   |  | CP[1:0] = 00  |     | 70   |       |                  |
| $V_{CP}$     | Charge-pump output voltage                   | PLL locked  |     | 1.95 |       | V                |
| $I_{CPOFF}$  | Charge-pump leakage current                  | $V_{CP} = 2\text{ V}$ , $T_A = 25^\circ\text{C}$  | -15 |      | 15    | nA               |
| $I_{BS}$     | Band-switch driver output current (BS1–BS4)  |   |     |      | 10    | mA               |
| $V_{BS1}$    | Band-switch driver output voltage (BS1–BS4)  | $I_{BS} = 10\text{ mA}$   |     | 3    |       | V                |
| $V_{BS2}$    |  | $I_{BS} = 10\text{ mA}$ , $V_{CC} = 5\text{ V}$ , $T_A = 25^\circ\text{C}$                  |     | 3.5  | 3.7   |                  |
| $I_{BSOFF}$  | Band-switch driver leakage current (BS1–BS4) | $V_{BS} = 0\text{ V}$   |     |      | 8     | $\mu\text{A}$    |
| $I_{P5}$     | Band-switch port sink current (P5/ADC)       |   |     |      | -5    | mA               |
| $V_{P5ON}$   | Band-switch port output voltage (P5/ADC)     | $I_{P5} = -2\text{ mA}$ , $V_{CC} = 5\text{ V}$ , $T_A = 25^\circ\text{C}$                  |     |      | 0.6   | V                |

## RF AGC

 $V_{CC} = 5\text{ V}$ ,  $T_A = 25^\circ\text{C}$ , measured in [Figure 24](#) reference measurement circuit at 50- $\Omega$  system, IF = 44 MHz, IF filter characteristics:  $f_{peak} = 44\text{ MHz}$  (unless otherwise noted)

| PARAMETER      |  | TEST CONDITIONS             | TYP | UNIT             |
|----------------|--|-----------------------------|-----|------------------|
| $I_{OAGC0}$    | RF AGC output source current               | ATC = 0                     | 300 | nA               |
| $I_{OAGC1}$    |  | ATC = 1                     | 15  | $\mu\text{A}$    |
| $I_{OAGCSINK}$ | RF AGC peak sink current                   | ATC = 0                     | 100 | $\mu\text{A}$    |
| $V_{AGCSP00}$  | Start-point IF output level <sup>(1)</sup> | T1/ATSS = 0, ATP[2:0] = 000 | 117 | dB $\mu\text{V}$ |
| $V_{AGCSP01}$  |  | T1/ATSS = 0, ATP[2:0] = 001 | 114 |                  |
| $V_{AGCSP02}$  |  | T1/ATSS = 0, ATP[2:0] = 010 | 111 |                  |
| $V_{AGCSP03}$  |  | T1/ATSS = 0, ATP[2:0] = 011 | 108 |                  |
| $V_{AGCSP04}$  |  | T1/ATSS = 0, ATP[2:0] = 100 | 105 |                  |
| $V_{AGCSP05}$  |  | T1/ATSS = 0, ATP[2:0] = 101 | 102 |                  |
| $V_{AGCSP06}$  |  | T1/ATSS = 0, ATP[2:0] = 110 | 99  |                  |
| $V_{AGCSP10}$  |  | T1/ATSS = 1, ATP[2:0] = 000 | 112 |                  |
| $V_{AGCSP11}$  |  | T1/ATSS = 1, ATP[2:0] = 001 | 109 |                  |
| $V_{AGCSP12}$  |  | T1/ATSS = 1, ATP[2:0] = 010 | 106 |                  |
| $V_{AGCSP13}$  |  | T1/ATSS = 1, ATP[2:0] = 011 | 103 |                  |
| $V_{AGCSP14}$  |  | T1/ATSS = 1, ATP[2:0] = 100 | 100 |                  |
| $V_{AGCSP15}$  |  | T1/ATSS = 1, ATP[2:0] = 101 | 97  |                  |
| $V_{AGCSP16}$  |  | T1/ATSS = 1, ATP[2:0] = 110 | 94  |                  |

(1) When AISL = 1, RF AGC function is not available at VHF-L band.

## Mixer, Oscillator, IF Amplifier

$V_{CC} = 5\text{ V}$ ,  $T_A = 25^\circ\text{C}$ , measured in Figure 24 reference measurement circuit at 50- $\Omega$  system, IF = 44 MHz, IF filter characteristics:  $f_{\text{peak}} = 44\text{ MHz}$  (unless otherwise noted)

| PARAMETER              |   | TEST CONDITIONS   | TYP | UNIT       |
|------------------------|---|---|-----|------------|
| $G_{c1}$               | Conversion gain (mixer-IF amplifier), VHF-L                 | $f_{\text{in}} = 57\text{ MHz}^{(1)}$                             | 35  | dB         |
| $G_{c3}$               |   | $f_{\text{in}} = 171\text{ MHz}^{(1)}$                            | 35  |            |
| $G_{c4}$               | Conversion gain (mixer-IF amplifier), VHF-H                 | $f_{\text{in}} = 177\text{ MHz}^{(1)}$                            | 35  | dB         |
| $G_{c6}$               |   | $f_{\text{in}} = 467\text{ MHz}^{(1)}$                            | 35  |            |
| $G_{c7}$               | Conversion gain (mixer-IF amplifier), UHF                   | $f_{\text{in}} = 473\text{ MHz}^{(1)}$                            | 35  | dB         |
| $G_{c9}$               |   | $f_{\text{in}} = 864\text{ MHz}^{(1)}$                            | 35  |            |
| $NF_1$                 | Noise figure, VHF-L   | $f_{\text{in}} = 57\text{ MHz}$                                   | 9   | dB         |
| $NF_3$                 |   | $f_{\text{in}} = 171\text{ MHz}$                                  | 9   |            |
| $NF_4$                 | Noise figure, VHF-H   | $f_{\text{in}} = 177\text{ MHz}$                                  | 9   | dB         |
| $NF_6$                 |   | $f_{\text{in}} = 467\text{ MHz}$                                  | 9   |            |
| $NF_7$                 | Noise figure, UHF   | $f_{\text{in}} = 473\text{ MHz}$                                  | 12  | dB         |
| $NF_9$                 |   | $f_{\text{in}} = 864\text{ MHz}$                                  | 12  |            |
| $CM_1$                 | Input voltage causing 1% cross-modulation distortion, VHF-L | $f_{\text{in}} = 57\text{ MHz}^{(2)}$                             | 79  | dB $\mu$ V |
| $CM_3$                 |   | $f_{\text{in}} = 171\text{ MHz}^{(2)}$                            | 79  |            |
| $CM_4$                 | Input voltage causing 1% cross-modulation distortion, VHF-H | $f_{\text{in}} = 177\text{ MHz}^{(2)}$                            | 79  | dB $\mu$ V |
| $CM_6$                 |   | $f_{\text{in}} = 467\text{ MHz}^{(2)}$                            | 79  |            |
| $CM_7$                 | Input voltage causing 1% cross-modulation distortion, UHF   | $f_{\text{in}} = 473\text{ MHz}^{(2)}$                            | 77  | dB $\mu$ V |
| $CM_9$                 |   | $f_{\text{in}} = 864\text{ MHz}^{(2)}$                            | 77  |            |
| $V_{\text{IFO1}}$      | IF output voltage, VHF-L                                    | $f_{\text{in}} = 57\text{ MHz}$                                   | 117 | dB $\mu$ V |
| $V_{\text{IFO3}}$      |   | $f_{\text{in}} = 171\text{ MHz}$                                  | 117 |            |
| $V_{\text{IFO4}}$      | IF output voltage, VHF-H                                    | $f_{\text{in}} = 177\text{ MHz}$                                  | 117 | dB $\mu$ V |
| $V_{\text{IFO6}}$      |   | $f_{\text{in}} = 467\text{ MHz}$                                  | 117 |            |
| $V_{\text{IFO7}}$      | IF output voltage, UHF                                      | $f_{\text{in}} = 473\text{ MHz}$                                  | 117 | dB $\mu$ V |
| $V_{\text{IFO9}}$      |   | $f_{\text{in}} = 864\text{ MHz}$                                  | 117 |            |
| $\Phi_{\text{PLVL11}}$ | Phase noise, VHF-L  | $f_{\text{in}} = 57\text{ MHz}$ , Offset = 1 kHz <sup>(3)</sup>   | -90 | dBc/Hz     |
| $\Phi_{\text{PLVL12}}$ |   | $f_{\text{in}} = 57\text{ MHz}$ , Offset = 10 kHz <sup>(4)</sup>  | -95 |            |
| $\Phi_{\text{PLVL31}}$ |   | $f_{\text{in}} = 171\text{ MHz}$ , Offset = 1 kHz <sup>(5)</sup>  | -85 |            |
| $\Phi_{\text{PLVL32}}$ |   | $f_{\text{in}} = 171\text{ MHz}$ , Offset = 10 kHz <sup>(4)</sup> | -95 |            |
| $\Phi_{\text{PLVL41}}$ | Phase noise, VHF-H  | $f_{\text{in}} = 177\text{ MHz}$ , Offset = 1 kHz <sup>(3)</sup>  | -85 | dBc/Hz     |
| $\Phi_{\text{PLVL42}}$ |   | $f_{\text{in}} = 177\text{ MHz}$ , Offset = 10 kHz <sup>(4)</sup> | -90 |            |
| $\Phi_{\text{PLVL61}}$ |   | $f_{\text{in}} = 467\text{ MHz}$ , Offset = 1 kHz <sup>(5)</sup>  | -77 |            |
| $\Phi_{\text{PLVL62}}$ |   | $f_{\text{in}} = 467\text{ MHz}$ , Offset = 10 kHz <sup>(4)</sup> | -90 |            |
| $\Phi_{\text{PLVL71}}$ | Phase noise, UHF  | $f_{\text{in}} = 473\text{ MHz}$ , Offset = 1 kHz <sup>(3)</sup>  | -80 | dBc/Hz     |
| $\Phi_{\text{PLVL72}}$ |   | $f_{\text{in}} = 473\text{ MHz}$ , Offset = 10 kHz <sup>(4)</sup> | -85 |            |
| $\Phi_{\text{PLVL91}}$ |   | $f_{\text{in}} = 864\text{ MHz}$ , Offset = 1 kHz <sup>(5)</sup>  | -77 |            |
| $\Phi_{\text{PLVL92}}$ |   | $f_{\text{in}} = 864\text{ MHz}$ , Offset = 10 kHz <sup>(4)</sup> | -90 |            |

- (1) IF = 44 MHz, RF input level = 70 dB $\mu$ V, differential output  
(2)  $f_{\text{undes}} = f_{\text{des}} \pm 6\text{ MHz}$ ,  $P_{\text{in}} = 70\text{ dB}\mu\text{V}$ , AM 1 kHz, 30%, DES/CM = S/I = 46 dB  
(3) CP[1:0] = 10 (CP current 350  $\mu$ A), RS[2:0] = 011 (reference divider 64)  
(4) CP[1:0] = 00 (CP current 70  $\mu$ A), RS[2:0] = 100 (reference divider 128)  
(5) CP[1:0] = 11 (CP current 600  $\mu$ A), RS[2:0] = 011 (reference divider 64)

## IF Gain Controlled Amplifier

$V_{CC} = 5\text{ V}$ ,  $T_A = 25^\circ\text{C}$ , measured in [Figure 24](#) reference measurement circuit at 50- $\Omega$  system,  $f = 44\text{ MHz}$  (unless otherwise noted)

| PARAMETER      |  | TEST CONDITIONS  | MIN | TYP | MAX      | UNIT          |
|----------------|--|--|-----|-----|----------|---------------|
| $I_{IFGCA}$    | Input current (IF GCA CTRL)                  | $V_{IFGCA} = 3\text{ V}$   |     | 30  | 60       | $\mu\text{A}$ |
| $V_{IFGCAMAX}$ | Maximum gain control voltage                 | Gain maximum   | 2.5 |     | $V_{CC}$ | V             |
| $V_{IFGCAMIN}$ | Minimum gain control voltage                 | Gain minimum   | 0   |     | 0.4      | V             |
| $G_{IFGCAMAX}$ | Maximum gain                                 | $V_{IFGCA} = 3\text{ V}$   | 49  | 53  | 57       | dB            |
| $G_{IFGCAMIN}$ | Minimum gain                                 | $V_{IFGCA} = 0\text{ V}$   | -4  | -1  | 2        | dB            |
| $GCR_{IFGCA}$  | Gain control range                           | $V_{IFGCA} = 0\text{ V to }3\text{ V}$   |     | 54  |          | dB            |
| $V_{IFGCAOUT}$ | Output voltage                               | Single-ended output  |     | 2.1 |          | Vp-p          |
| $NF_{IFGCA}$   | Noise figure                                 | $V_{IFGCA} = 3\text{ V}$   |     | 8.5 |          | dB            |
| $IM3_{IFGCA}$  | Third order intermodulation distortion       | $f_{IFGCAIN1} = 43\text{ MHz}$ ,<br>$f_{IFGCAIN2} = 44\text{ MHz}$ ,<br>$V_{IFGCAOUT} = -2\text{ dBm}$ ,<br>$V_{IFGCA} = 3\text{ V}$ |     | -50 |          | dBc           |
| $IIP3_{IFGCA}$ | Input intercept point                        | $V_{IFGCA} = 0\text{ V}$   |     | 11  |          | dBm           |
| $R_{IFGCAIN}$  | Input resistance (IF GCA IN1, IF GCA IN2)    |  |     | 1   |          | k $\Omega$    |
| $R_{IFGCAOUT}$ | Output resistance (IF GCA OUT1, IF GCA OUT2) |  |     | 19  |          | $\Omega$      |

## FUNCTIONAL DESCRIPTION

### I<sup>2</sup>C Bus Mode

#### I<sup>2</sup>C Write Mode (R/W = 0)

**Table 1. Write Data Format**

|                       | MSB |     |      |      |      |     | LSB     |         |   | (1) |
|-----------------------|-----|-----|------|------|------|-----|---------|---------|---|-----|
| Address byte (ADB)    | 1   | 1   | 0    | 0    | 0    | MA1 | MA0     | R/W = 0 | A |     |
| Divider byte 1 (DB1)  | 0   | N14 | N13  | N12  | N11  | N10 | N9      | N8      | A |     |
| Divider byte 2 (DB2)  | N7  | N6  | N5   | N4   | N3   | N2  | N1      | N0      | A |     |
| Control byte 1 (CB1)  | 1   | 0   | ATP2 | ATP1 | ATP0 | RS2 | RS1     | RS0     | A |     |
| Band-switch byte (BB) | CP1 | CP0 | AISL | P5   | BS4  | BS3 | BS2     | BS1     | A |     |
| Control byte 2 (CB2)  | 1   | 1   | ATC  | STBY | T3   | T2  | T1/ATSS | T0/XLO  | A |     |

(1) A: Acknowledge

**Table 2. Write Data Symbol Description**

| SYMBOL                        | DESCRIPTION  | DEFAULT                        |     |     |  |   |   |        |   |   |        |   |   |     |   |
|-------------------------------|--|--------------------------------|-----|-----|--|---|---|--------|---|---|--------|---|---|-----|---|
| MA[1:0]                       | Address-set bits (see <a href="#">Table 3</a> )  |                                |     |     |  |   |   |        |   |   |        |   |   |     |   |
| N[14:0]                       | Programmable counter set bits<br>$N = N14 \times 2^{14} + N13 \times 2^{13} + \dots + N1 \times 2 + N0$  | N14 = N13 = N12 = ... = N0 = 0 |     |     |  |   |   |        |   |   |        |   |   |     |   |
| ATP[2:0]                      | RF AGC start-point control bits (see <a href="#">Table 4</a> )   | ATP[2:0] = 011                 |     |     |  |   |   |        |   |   |        |   |   |     |   |
| RS[2:0]                       | Reference divider ratio-selection bits (see <a href="#">Table 5</a> )  | RS[2:0] = 111                  |     |     |  |   |   |        |   |   |        |   |   |     |   |
| CP[1:0]                       | Charge-pump current-set bit (see <a href="#">Table 6</a> )   | CP[1:0] = 11                   |     |     |  |   |   |        |   |   |        |   |   |     |   |
| AISL                          | RF AGC detector input selection bit<br>AISL = 0: IF amplifier<br>AISL = 1: Mixer output  | AISL = 0                       |     |     |  |   |   |        |   |   |        |   |   |     |   |
| P5                            | Port output/ADC input control bit<br>P5 = 0: ADC INPUT<br>P5 = 1: Tr = ON  | P5 = 0                         |     |     |  |   |   |        |   |   |        |   |   |     |   |
| BS[4:1]                       | Band-switch control bits<br>BSn = 0: Tr = OFF<br>BSn = 1: Tr = ON  | BSn = 0                        |     |     |  |   |   |        |   |   |        |   |   |     |   |
|                               | Band selection by BS[1:2]<br><table border="1"> <thead> <tr> <th>BS1</th> <th>BS2</th> <th></th> </tr> </thead> <tbody> <tr> <td>1</td> <td>0</td> <td>VHF-LO</td> </tr> <tr> <td>0</td> <td>1</td> <td>VHF-HI</td> </tr> <tr> <td>0</td> <td>0</td> <td>UHF</td> </tr> <tr> <td>1</td> <td>1</td> <td>Reserved</td> </tr> </tbody> </table> |                                | BS1 | BS2 |  | 1 | 0 | VHF-LO | 0 | 1 | VHF-HI | 0 | 0 | UHF | 1 |
| BS1                           | BS2  |                                |     |     |  |   |   |        |   |   |        |   |   |     |   |
| 1                             | 0  | VHF-LO                         |     |     |  |   |   |        |   |   |        |   |   |     |   |
| 0                             | 1  | VHF-HI                         |     |     |  |   |   |        |   |   |        |   |   |     |   |
| 0                             | 0  | UHF                            |     |     |  |   |   |        |   |   |        |   |   |     |   |
| 1                             | 1  | Reserved                       |     |     |  |   |   |        |   |   |        |   |   |     |   |
| ATC                           | RF AGC current-set bit<br>ATC = 0: Current = 300 nA<br>ATC = 1: Current = 15 $\mu$ A   | ATC = 0                        |     |     |  |   |   |        |   |   |        |   |   |     |   |
| STBY                          | Power standby mode-control bit<br>STBY = 0: Normal operation<br>STBY = 1: Standby mode/stop MOP function<br>(XTALOUT is available even in standby mode)  | STBY = 0                       |     |     |  |   |   |        |   |   |        |   |   |     |   |
| T3, T2,<br>T1/ATSS,<br>T0/XLO | TEST bits, RFAGC shift bit, XTALOUT control bit (see <a href="#">Table 7</a> )   | T[3:0] = 0010                  |     |     |  |   |   |        |   |   |        |   |   |     |   |
| X                             | Don't care   |                                |     |     |  |   |   |        |   |   |        |   |   |     |   |

**Table 3. Address Selection**

| MA1 | MA0 | VOLTAGE APPLIED ON AS INPUT                                |
|-----|-----|--|
| 0   | 0   | 0 V to 0.1 V <sub>CC</sub> (Low)                           |
| 0   | 1   | OPEN, or 0.2 V <sub>CC</sub> to 0.3 V <sub>CC</sub> (Mid2) |
| 1   | 0   | 0.4 V <sub>CC</sub> to 0.6 V <sub>CC</sub> (Mid1)          |
| 1   | 1   | 0.9 V <sub>CC</sub> to V <sub>CC</sub> (High)              |

**Table 4. RF AGC Start Point<sup>(1)</sup>**

| T1/ATSS | ATP2 | ATP1 | ATP0 | IFOUT LEVEL (dB $\mu$ V) |
|---------|------|------|------|--------------------------|
| 0       | 0    | 0    | 0    | 117                      |
| 0       | 0    | 0    | 1    | 114                      |
| 0       | 0    | 1    | 0    | 111                      |
| 0       | 0    | 1    | 1    | 108                      |
| 0       | 1    | 0    | 0    | 105                      |
| 0       | 1    | 0    | 1    | 102                      |
| 0       | 1    | 1    | 0    | 99                       |
| 0       | 1    | 1    | 1    | Disabled                 |
| 1       | 0    | 0    | 0    | 112                      |
| 1       | 0    | 0    | 1    | 109                      |
| 1       | 0    | 1    | 0    | 106                      |
| 1       | 0    | 1    | 1    | 103                      |
| 1       | 1    | 0    | 0    | 100                      |
| 1       | 1    | 0    | 1    | 97                       |
| 1       | 1    | 1    | 0    | 94                       |
| 1       | 1    | 1    | 1    | Disabled                 |

(1) When AISL = 1, RF AGC function is not available at VHF-L band (output level is undefined).

**Table 5. Reference Divider Ratio**

| RS2 | RS1 | RS0 | REFERENCE DIVIDER RATIO |
|-----|-----|-----|-------------------------|
| 0   | 0   | 0   | 24                      |
| 0   | 0   | 1   | 28                      |
| 0   | 1   | 0   | 50                      |
| 0   | 1   | 1   | 64                      |
| 1   | 0   | 0   | 128                     |
| 1   | X   | 1   | 80                      |

**Table 6. Charge-Pump Current**

| CP1 | CP0 | CHARGE PUMP CURRENT ( $\mu$ A) |
|-----|-----|--------------------------------|
| 0   | 0   | 70                             |
| 0   | 1   | 140                            |
| 1   | 0   | 350                            |
| 1   | 1   | 600                            |

**Table 7. Test Bits/XTALOUT Control** <sup>(1)</sup>

| T3 | T2 | T1/ATSS | T0/XLO | DEVICE OPERATION | XTALOUT<br>4-MHz OUTPUT |
|----|----|---------|--------|------------------|-------------------------|
| 0  | 0  | X       | 0      | Normal operation | Enabled                 |
| 0  | 0  | X       | 1      | Normal operation | Disabled                |
| X  | 1  | X       | X      | Test mode        | Not available           |
| 1  | X  | X       | X      | Test mode        | Not available           |

(1) RFAGC and XTALOUT are not available in test mode.

### Example I<sup>2</sup>C Data Write Sequences

Telegram examples:

Start-ADB-DB1-DB2-CB1-BB-CB2-Stop  
 Start-ADB-DB1-DB2-Stop  
 Start-ADB-CB1-BB-CB2-Stop  
 Start-ADB-CB1-BB-Stop  
 Start-ADB-CB2-Stop

Abbreviations:

ADB: Address byte  
 BB: Band-switch byte  
 CB1: Control byte 1  
 CB2: Control byte 2  
 DB1: Divider byte 1  
 DB2: Divider byte 2  
 Start: Start condition  
 Stop: Stop condition

### I<sup>2</sup>C Read Mode ( $R/\overline{W} = 1$ )

**Table 8. Read Data Format (A: Acknowledge)**

|                    | MSB |    |   |   |   |     |     | LSB                  |   |
|--------------------|-----|----|---|---|---|-----|-----|----------------------|---|
| Address byte (ADB) | 1   | 1  | 0 | 0 | 0 | MA1 | MA0 | $R/\overline{W} = 1$ | A |
| Status byte (SB)   | POR | FL | 1 | 1 | X | A2  | A1  | A0                   | – |

**Table 9. Read Data Symbol Description**

| SYMBOL  | DESCRIPTION   | DEFAULT |
|---------|---|---------|
| MA[1:0] | Address set bits (see <a href="#">Table 3</a> )   |         |
| POR     | Power-on-reset flag<br>POR set: power on<br>POR reset: end-of-data transmission procedure | POR = 1 |
| FL      | In-lock flag<br>PLL locked (FL = 1), unlocked (FL = 0)                                    |         |
| A[2:0]  | Digital data of ADC (see <a href="#">Table 10</a> )<br>Bit P5 must be set to 0.           |         |

Table 10. ADC Level<sup>(1)</sup>

| A2 | A1 | A0 | VOLTAGE APPLIED ON ADC INPUT                |
|----|----|----|---|
| 1  | 0  | 0  | 0.6 V <sub>CC</sub> to V <sub>CC</sub>      |
| 0  | 1  | 1  | 0.45 V <sub>CC</sub> to 0.6 V <sub>CC</sub> |
| 0  | 1  | 0  | 0.3 V <sub>CC</sub> to 0.45 V <sub>CC</sub> |
| 0  | 0  | 1  | 0.15 V <sub>CC</sub> to 0.3 V <sub>CC</sub> |
| 0  | 0  | 0  | 0 V to 0.15 V <sub>CC</sub>                 |

(1) Accuracy is  $0.03 \times V_{CC}$ .

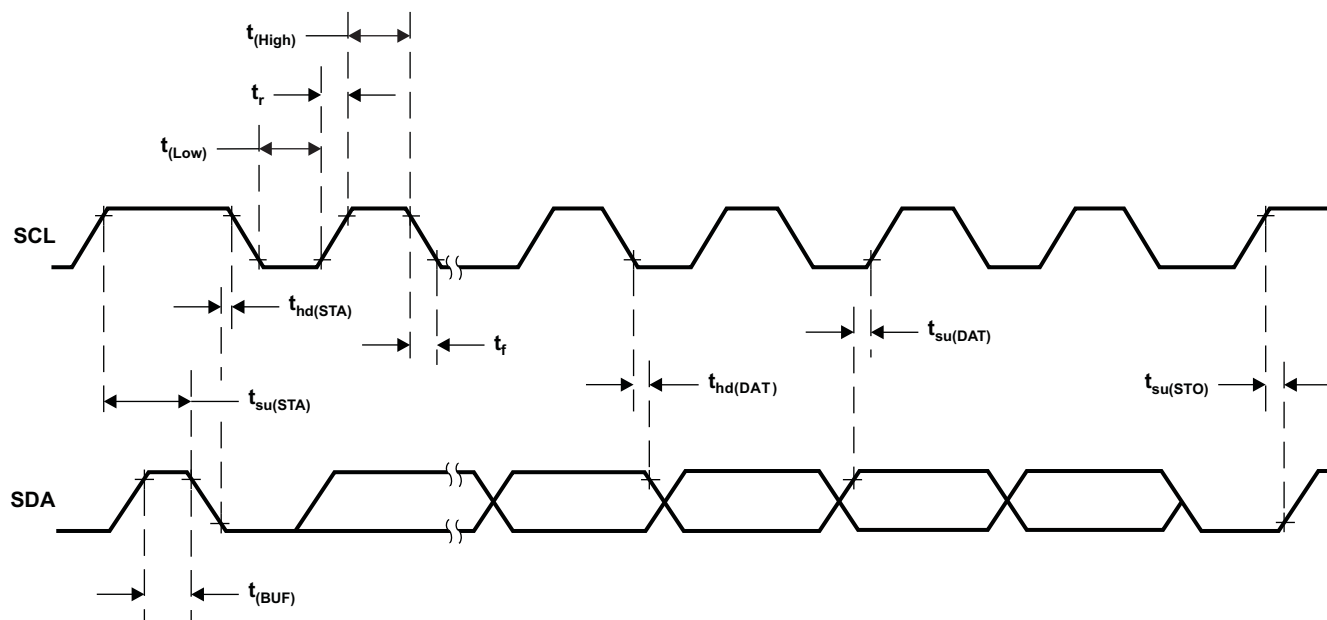
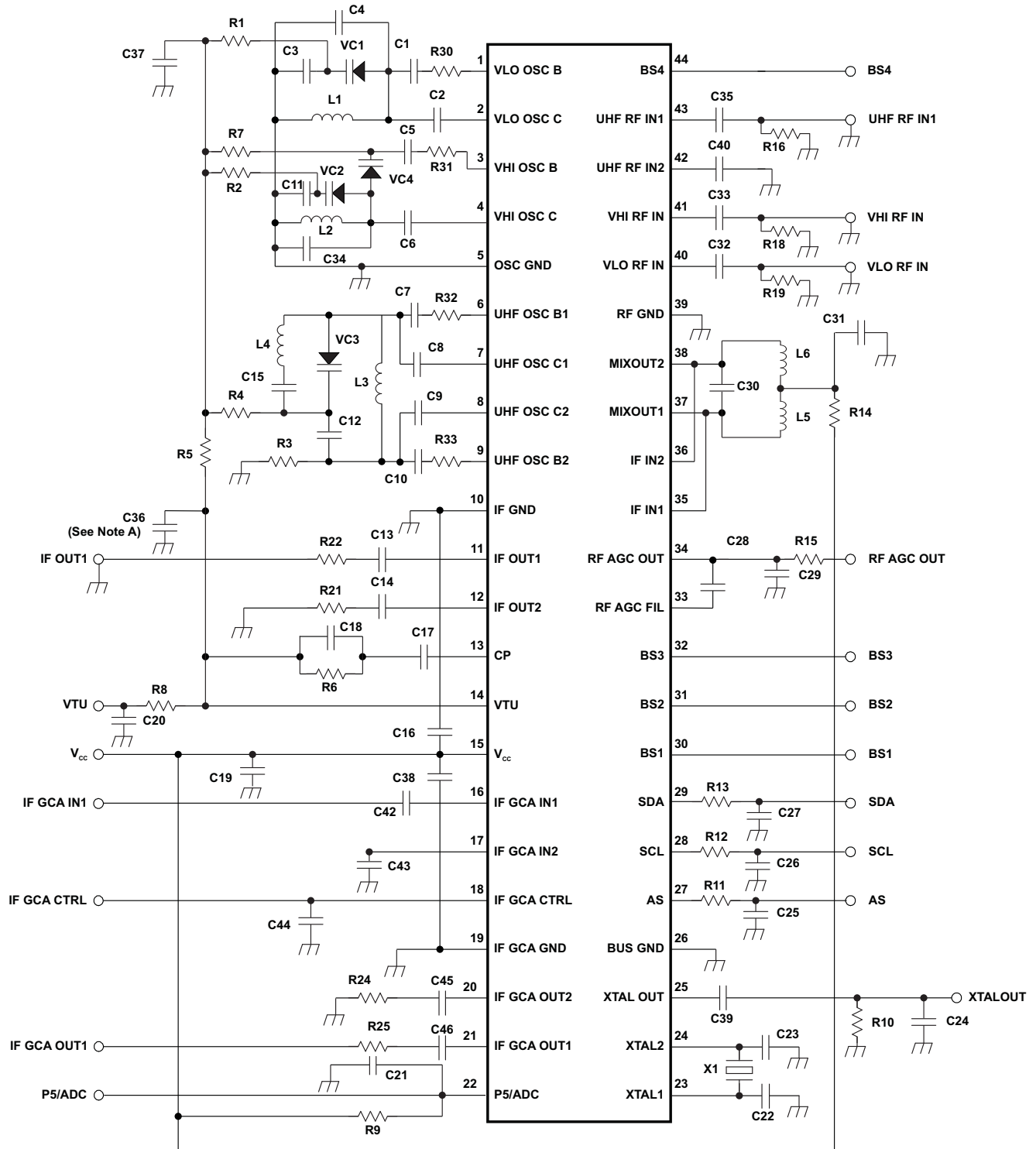


Figure 23. I<sup>2</sup>C Timing Chart

APPLICATION INFORMATION



- A. To prevent abnormal oscillation, connect C36, which does not affect a PLL.
- B. This application information is advisory, and a performance check is required for actual application circuits. TI assumes no responsibility for the consequences of the use of this circuit, nor for any infringement of patent or patent rights of third parties that may result from its use.

Figure 24. Reference Measurement Circuit

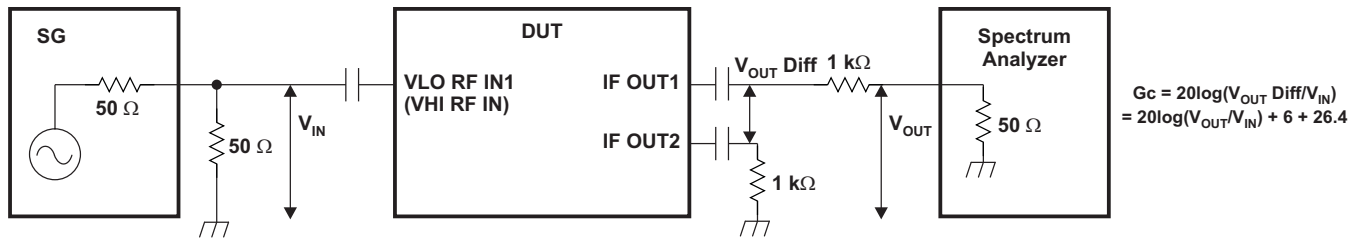


**Component Values for Measurement Circuit**

| <b>PART NAME</b>       | <b>VALUE</b> | <b>PART NAME</b>       | <b>VALUE</b>              |
|------------------------|--------------|------------------------|---------------------------|
| C1 (VLO OSC B)         | 1 pF         | C43 (IF GCA IN2)       | 2.2 nF                    |
| C2 (VLO OSC C)         | 2 pF         | C44 (IF GCA CTRL)      | 2.2 nF                    |
| C3 (VLO OSC)           | 47 pF        | C45 (IF GCA OUT1)      | 2.2 nF                    |
| C4 (VLO OSC)           | Open         | C46 (IF GCA OUT2)      | 2.2 nF                    |
| C5 (VHI OSC)           | 7 pF         | L1 (VLO OSC)           | φ3,0 mm, 7T, wire 0,32 mm |
| C6 (VHI OSC C)         | 5 pF         | L2 (VHI OSC)           | φ2,0 mm, 3T, wire 0,4 mm  |
| C7 (UHF OSC B1)        | 1.5 pF       | L3 (UHF OSC)           | φ1,8 mm, 3T, wire 0,4 mm  |
| C8 (UHF OSC C1)        | 1 pF         | L4 (UHF OSC)           | φ1,8 mm, 3T, wire 0,4 mm  |
| C9 (UHF OSC C2)        | 1 pF         | L5 (MIXOUT)            | 680 nH (LK1608R68K-T)     |
| C10 (UHF OSC B2)       | 1.5 pF       | L6 (MIXOUT)            | 680 nH (LK1608R68K-T)     |
| C11 (VHI OSC)          | 51 pF        | R1 (VLO OSC)           | 3.3 kΩ                    |
| C12 (UHF OSC)          | 10 pF        | R2 (VHI OSC)           | 3.3 kΩ                    |
| C13 (IF OUT)           | 2.2 nF       | R3 (UHF OSC)           | 2.2 kΩ                    |
| C14 (IF OUT)           | 2.2 nF       | R4 (UHF OSC)           | 1 kΩ                      |
| C15 (UHF OSC)          | 100 pF       | R5 (VTU)               | 3 kΩ                      |
| C16 (V <sub>CC</sub> ) | 4.7 nF       | R6 (CP)                | 47 kΩ                     |
| C17 (CP)               | 0.01 μF/50 V | R7 (VHI OSC)           | 3.3 kΩ                    |
| C18 (CP)               | 22 pF/50 V   | R8 (VTU)               | 20 kΩ                     |
| C19 (V <sub>CC</sub> ) | 2.2 nF       | R9 (P5/ADC)            | Open                      |
| C20 (VTU)              | 2.2 nF/50 V  | R10 (XTALOUT)          | 5.1 kΩ                    |
| C21 (P5/ADC)           | Open         | R11 (AS)               | 330 Ω                     |
| C22 (XTAL)             | 27 pF        | R12 (SCL)              | 330 Ω                     |
| C23 (XTAL)             | 27 pF        | R13 (SDA)              | 330 Ω                     |
| C24 (XTALOUT)          | 10 pF        | R14 (V <sub>CC</sub> ) | 0                         |
| C25 (AS)               | 22 pF        | R15 (RF AGC OUT)       | 0                         |
| C26 (SCL)              | Open         | R16 (UHF RF IN1)       | (50 Ω)                    |
| C27 (SDA)              | Open         | R18 (VHI RF IN)        | (50 Ω)                    |
| C28 (AGC FIL)          | 1 nF         | R19 (VLO RF IN)        | (50 Ω)                    |
| C29 (RF AGC OUT)       | 0.15 μF      | R21 (IF OUT2)          | 1 kΩ                      |
| C30 (MIXOUT)           | 4 pF         | R22 (IF OUT1)          | 1 kΩ                      |
| C31 (MIXOUT)           | 2.2 nF       | R24 (IF GCA OUT1)      | 250 Ω                     |
| C32 (VLO RF IN)        | 2.2 nF       | R25 (IF GCA OUT2)      | 200 Ω                     |
| C33 (VHI RF IN)        | 2.2 nF       | R30 (VLO OSC B)        | 0                         |
| C34 (VHI OSC)          | 0.5 pF       | R31 (VHI OSC B)        | 4.7 Ω                     |
| C35 (UHF RF IN1)       | 2.2 nF       | R32 (UHF OSC B1)       | 0                         |
| C36 (VTU)              | 22 pF        | R33 (UHF OSC B2)       | 0                         |
| C37 (VTU)              | 2.2 nF/50 V  | VC1 (VLO OSC)          | MA2S374                   |
| C38 (V <sub>CC</sub> ) | 0.1 μF       | VC2 (VHI OSC)          | MA2S374                   |
| C39 (XTALOUT)          | 2.2 nF       | VC3 (UHF OSC)          | MA2S372                   |
| C40 (UHF RF IN2)       | 2.2 nF       | VC4 (VHI OSC)          | MA2S372                   |
| C42 (IF GCA IN1)       | 2.2 nF       | X1                     | 4-MHz crystal             |

APPLICATION INFORMATION (CONTINUED)

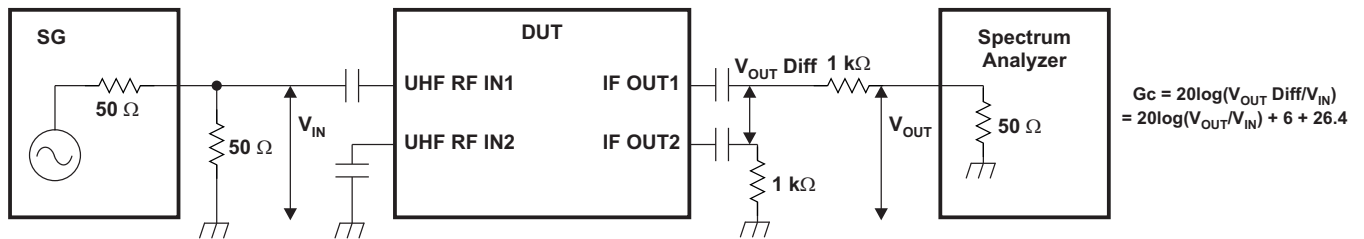
Test Circuits



$$G_c = 20\log(V_{OUT\ Diff}/V_{IN})$$

$$= 20\log(V_{OUT}/V_{IN}) + 6 + 26.4$$

Figure 25. VHF-Conversion Gain-Measurement Circuit



$$G_c = 20\log(V_{OUT\ Diff}/V_{IN})$$

$$= 20\log(V_{OUT}/V_{IN}) + 6 + 26.4$$

Figure 26. UHF-Conversion Gain-Measurement Circuit

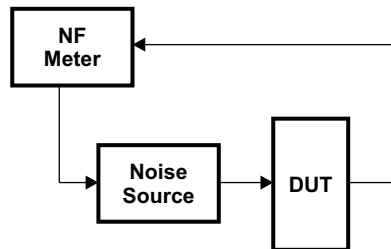


Figure 27. Noise-Figure Measurement Circuit

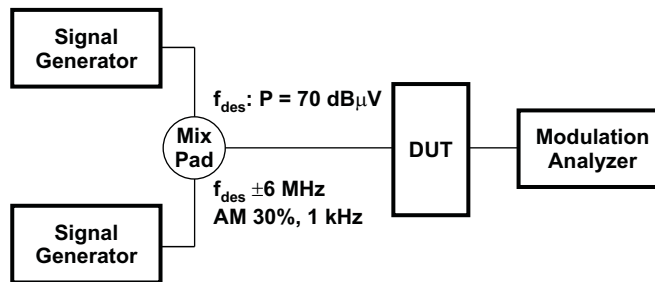


Figure 28. 1% Cross-Modulation Distortion Measurement Circuit

### TYPICAL CHARACTERISTICS

#### Band-Switch Driver Output Voltage (BS1–BS4)

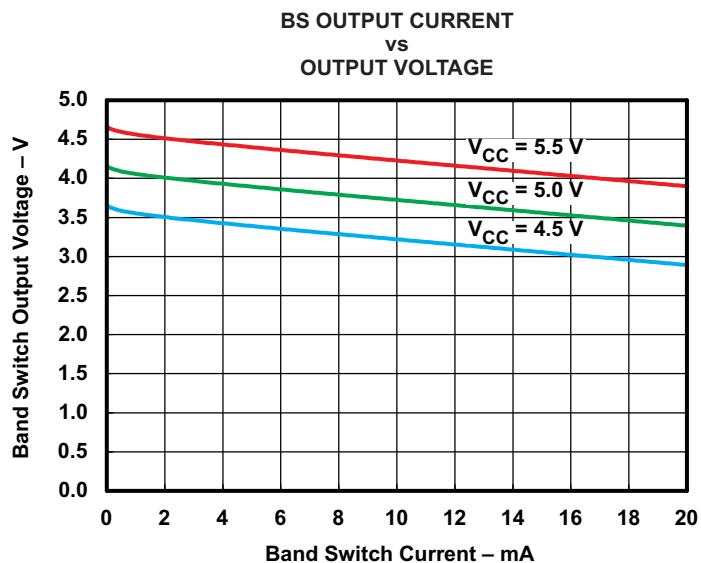


Figure 29. Band-Switch Driver Output Voltage

#### S-Parameter

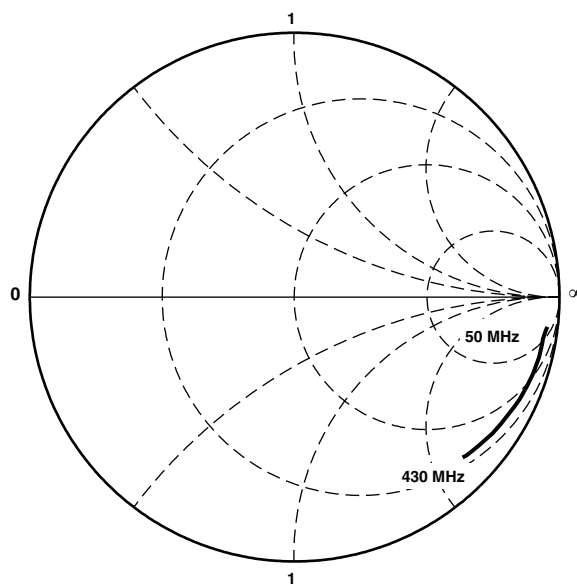


Figure 30. VLO RFIN, VHI RFIN

TYPICAL CHARACTERISTICS (continued)

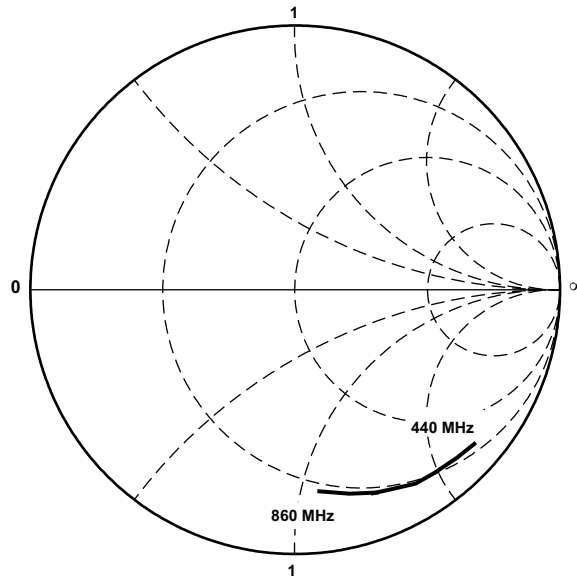


Figure 31. UHF RFIN

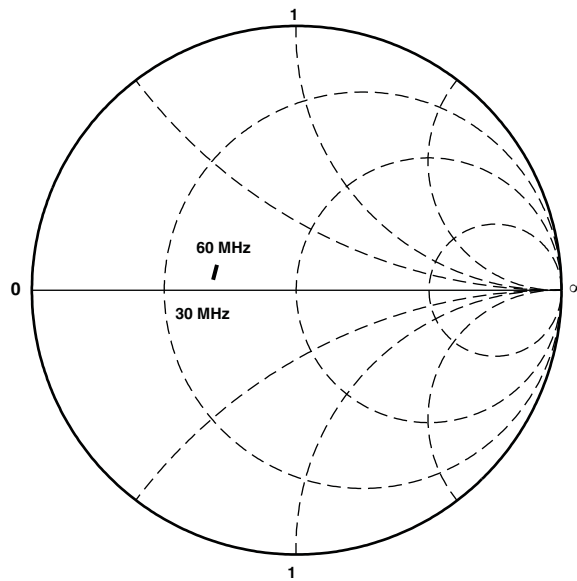


Figure 32. IFOUT

TYPICAL CHARACTERISTICS (continued)

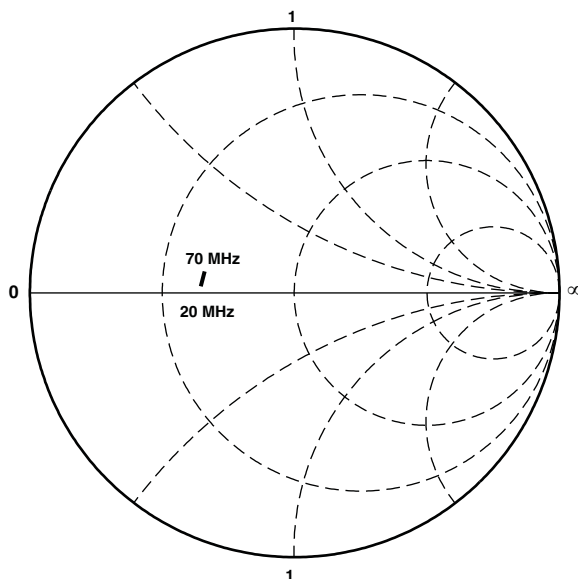


Figure 33. IF GCA OUT

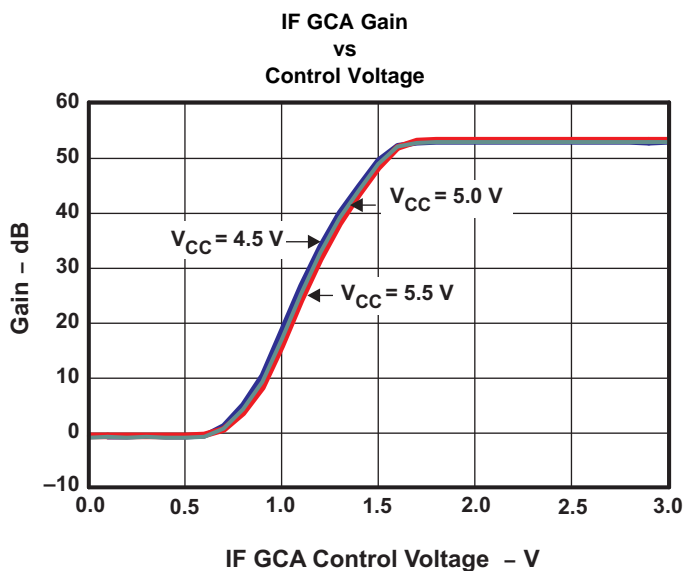


Figure 34. IF GCA Gain vs Control Voltage

**PACKAGING INFORMATION**

| Orderable Device | Status <sup>(1)</sup> | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
| SN761668DBTR     | ACTIVE                | TSSOP        | DBT             | 44   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-2-260C-1 YEAR          |

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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